



**ELECTRICAL CHARACTERISTICS** ( $T_{amb} = 25^{\circ}\text{C}$  unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>STATIC ELECTRICAL RATINGS</b>					
$BV_{DSS}$ Drain – Source Breakdown Voltage	$V_{GS} = 0$ $I_D = 1\text{mA}$	200			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$ Temperature Coefficient of Breakdown Voltage	Reference to $25^{\circ}\text{C}$ $I_D = 1\text{mA}$		0.29		$\text{V}/^{\circ}\text{C}$
$R_{DS(on)}$ Static Drain – Source On–State Resistance <sup>1</sup>	$V_{GS} = 10\text{V}$ $I_D = 14\text{A}$			0.100	$\Omega$
	$V_{GS} = 10\text{V}$ $I_D = 22\text{A}$			0.105	
$V_{GS(th)}$ Gate Threshold Voltage	$V_{DS} = V_{GS}$ $I_D = 250\mu\text{A}$	2		4	V
$g_{fs}$ Forward Transconductance <sup>1</sup>	$V_{DS} \geq 15\text{V}$ $I_{DS} = 14\text{A}$	9			$\text{S}(\bar{v})$
$I_{DSS}$ Zero Gate Voltage Drain Current	$V_{GS} = 0$ $V_{DS} = 0.8BV_{DSS}$ $T_J = 125^{\circ}\text{C}$			25	$\mu\text{A}$
				250	
$I_{GSS}$ Forward Gate – Source Leakage	$V_{GS} = 20\text{V}$			100	nA
$I_{GSS}$ Reverse Gate – Source Leakage	$V_{GS} = -20\text{V}$			-100	
<b>DYNAMIC CHARACTERISTICS</b>					
$C_{iss}$ Input Capacitance	$V_{GS} = 0$		3500		pF
$C_{oss}$ Output Capacitance	$V_{DS} = 25\text{V}$		700		
$C_{rss}$ Reverse Transfer Capacitance	$f = 1\text{MHz}$		110		
$Q_g$ Total Gate Charge <sup>1</sup>	$V_{GS} = 10\text{V}$ $I_D = 22\text{A}$ $V_{DS} = 0.5BV_{DSS}$	55		115	nC
$Q_{gs}$ Gate – Source Charge <sup>1</sup>	$I_D = 22\text{A}$	8		22	nC
$Q_{gd}$ Gate – Drain (“Miller”) Charge <sup>1</sup>	$V_{DS} = 0.5BV_{DSS}$	30		60	
$t_{d(on)}$ Turn–On Delay Time	$V_{DD} = 100\text{V}$ $I_D = 22\text{A}$ $R_G = 2.35\Omega$			35	ns
$t_r$ Rise Time				190	
$t_{d(off)}$ Turn–Off Delay Time				170	
$t_f$ Fall Time				130	
<b>SOURCE – DRAIN DIODE CHARACTERISTICS</b>					
$I_S$ Continuous Source Current				22	A
$I_{SM}$ Pulse Source Current <sup>2</sup>				88	
$V_{SD}$ Diode Forward Voltage	$I_S = 22\text{A}$ $T_J = 25^{\circ}\text{C}$ $V_{GS} = 0$			1.9	V
$t_{rr}$ Reverse Recovery Time	$I_F = 22\text{A}$ $T_J = 25^{\circ}\text{C}$			950	ns
$Q_{rr}$ Reverse Recovery Charge	$d_i / d_t \leq 100\text{A}/\mu\text{s}$ $V_{DD} \leq 50\text{V}$			9.0	$\mu\text{C}$
$t_{on}$ Forward Turn–On Time		Negligible			
<b>PACKAGE CHARACTERISTICS</b>					
$L_D$ Internal Drain Inductance (from centre of drain pad to die)			0.8		nH
$L_S$ Internal Source Inductance (from centre of source pad to end of source bond wire)			2.8		

**Notes**

- 1) Pulse Test: Pulse Width  $\leq 300\text{ms}$ ,  $\delta \leq 2\%$
- 2) Repetitive Rating – Pulse width limited by maximum junction temperature.